

What Is Claimed Is:

1. An imaging device module package comprising:

an image sensor chip for reading an image;

a circuit board electrically connected to said image

5 sensor chip;

a housing adhered on said circuit board, and having an opening at the top for allowing light to said imaging sensor chip and steps with rounded sides around said opening; and

10 a holder having a ring-shaped opening corresponding to said steps around said opening of the housing for interference fitting around said steps and an lens internally fitted to said holder.

15 2. The imaging device module package according to claim 1, further comprising a projection in an inner side of said housing for settling an iris filter or a cover glass.

20 3. The imaging device module package according to claim 1, further comprising a projection in an inner side of said holder for settling said lens, said projection face contacting with said opening of the housing.

4. The imaging device module package according to claim 1, wherein said circuit board is a flexible circuit board.